

Silicon Carbide Power MOSFET N-Channel Enhancement Mode

Features

- · Optimized package with separate driver source pin
- Lower profile TO-247-4 package body
- High blocking voltage with low on-resistance
- High-speed switching with low capacitances
- Fast intrinsic diode with low reverse recovery (Q,,)
- · Halogen free, RoHS compliant

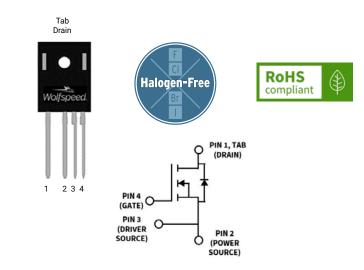
Benefits

- · Reduce switching losses and minimize gate ringing
- Higher system efficiency
- · Reduce cooling requirements
- Increase power density
- · Increase system switching frequency

Applications

- Motor Control
- EV Battery Chargers
- High Voltage DC/DC Converters
- Solar/ESS
- UPS
- Battery Voltage Range 400V-550V
- Enterprise PSU

Package



Part Number	Package	Marking	
C3M0025075K1	T0-247-4L LP	C3M0025075K1	

Key Parameters

Parameter	Symbol	Min.	Тур.	Max	Unit	Conditions	Note
Drain - Source Voltage	V _{DS}			750		T _c = 25°C	
Maximum Gate - Source Voltage	V _{GS(max)}	-8		+19	v	Transient	
Operational Gate-Source Voltage	V _{GS op}		-4/15			Static	Note 1
				80		$V_{GS} = 15 \text{ V}, T_{C} = 25 \text{ °C}, T_{J} \le 175 \text{ °C}$	Fig. 19
DC Continuous Drain Current	l _D			59	A	$V_{GS} = 15 \text{ V}, T_{C} = 100 \text{ °C}, T_{J} \le 175 \text{ °C}$	Note 2
Pulsed Drain Current	I _{DM}			251		t _{Pmax} limited by T _{jmax} V _{GS} = 15V, T _C = 25 °C	Fig. 22
Power Dissipation	P _D			262	W	$T_{c} = 25 ^{\circ} \text{C}, T_{J} = 175 ^{\circ} ^{\circ} ^{\circ}$	Fig. 20
Operating Junction and Storage Temperature	T _J , T _{stg}			-40 to +175	°C		
Solder Temperature	T _L			260		According to JEDEC J-STD-020	
Mounting Torque	M _D			1 8.8	Nm lbf-in	M3 or 6-32 screw	

Note (1): Recommended turn-on gate voltage is 15V with ±5% regulation tolerance, see Application Note PRD-04814 for additional details Note (2): Verified by design

Electrical Characteristics ($T_c = 25^{\circ}C$ unless otherwise specified)

Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Conditions	Note
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	750			٧	V _{GS} = 0 V, I _D = 100 μA	
V	Gate Threshold Voltage		2.6	3.8	٧	V _{DS} = V _{GS} , I _D = 9.22 mA	Fig. 11
V GS(th)			2.1		٧	$V_{DS} = V_{GS}$, $I_D = 9.22$ mA, $T_J = 175$ °C	
I _{DSS}	Zero Gate Voltage Drain Current		1	50	μA	$V_{DS} = 750 \text{ V}, V_{GS} = 0 \text{ V}$	
I_{GSS}	Gate-Source Leakage Current		10	250	nA	V _{GS} = 15 V, V _{DS} = 0 V	
$R_{\text{DS(on)}}$	Drain-Source On-State Resistance		25	34	mΩ	V _{GS} = 15 V, I _D = 33.5 A	Fig. 4,
03(011)			35			V _{GS} = 15 V, I _D = 33.5 A, T _J = 175°C	5, 6
G fs	Transconductance		24	1	S	V _{DS} = 20 V, I _{DS} = 33.5 A	Fig. 7
			18	-		V _{DS} = 20 V, I _{DS} = 33.5 A, T _J = 175°C	<u> </u>
C _{iss}	Input Capacitance		3055				
C_{oss}	Output Capacitance		158		pF	$V_{GS} = 0 \text{ V}, V_{DS} = 0 \text{V to } 500 \text{ V}$	Fig. 17, 18
C_{rss}	Reverse Transfer Capacitance		16			F = 100 kHz	
Eoss	Coss Stored Energy		23		μJ	Vac = 25 mV	Fig. 16
$C_{\text{o(er)}}$	Effective Output Capacitance (Energy Related)		201		pF		Note: 3
$C_{o(tr)}$	Effective Output Capacitance (Time Related)		291		pF	V _{GS} = 0 V, V _{DS} = 0 500V	
Eon	Turn-On Switching Energy (External Diode)		144			V_{DS} = 500 V, V_{GS} = -4 V/15 V, I_D = 33.5 A,	Fig. 26,
E _{OFF}	Turn Off Switching Energy (External Diode)		103		μJ	$R_{G(ext)}$ = 2.5 Ω, L= 59 μH, T_J = 175°C FWD = External SiC DIODE	28
Eon	Turn-On Switching Energy (Body Diode FWD)		224			V_{DS} = 500 V, V_{GS} = -4 V/15 V, I_D = 33.5 A, $R_{G(ext)}$ = 2.5 Ω , L= 59 μ H, T_J = 175°C	Fig. 26,
E _{OFF}	Turn-Off Switching Energy (Body Diode FWD)		92		μJ	FWD = Internal Body Diode	28
t _{d(on)}	Turn-On Delay Time		12				Fig. 27, 28
t _r	Rise Time		18]	V_{DD} = 500 V, V_{GS} = -4 V/15 V I_D = 33.5 A, $R_{G(ext)}$ = 2.5 Ω ,	
$t_{\text{d(off)}}$	Turn-Off Delay Time		31		ns	Timing relative to V _{DS}	
t f	Fall Time		10			inductive load	
$R_{\text{G(int)}}$	Internal Gate Resistance		2.0		Ω	f = 1 MHz, V _{AC} = 25 mV	
Q_gs	Gate to Source Charge	ate to Source Charge				V _{DS} = 500 V, V _{GS} = -4 V/15 V	
$Q_{\text{gd}} \\$			I _D = 33.5 A	Fig. 12			
$Q_{\mathfrak{g}}$	Total Gate Charge		119			Per IEC60747-8-4 pg 21	

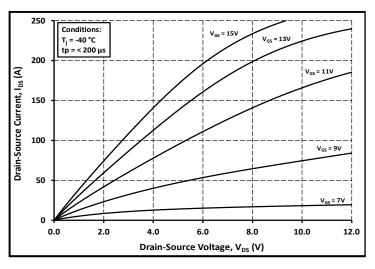
Note (3): $C_{o(er)}$, a lumped capacitance that gives same stored energy as Coss while Vds is rising from 0 to 500V $C_{o(tr)}$, a lumped capacitance that gives same charging time as Coss while Vds is rising from 0 to 500V

Reverse Diode Characteristics ($T_c = 25^{\circ}C$ unless otherwise specified)

Symbol	Parameter	Тур.	Max.	Unit	Test Conditions	Note
W	Died. Fermund Vellerer	4.8		٧	$V_{GS} = -4 \text{ V, I}_{SD} = 16.8 \text{ A, T}_{J} = 25 \text{ °C}$	Fig. 8,
V _{SD}	Diode Forward Voltage	4.2		٧	$V_{GS} = -4 \text{ V, I}_{SD} = 16.8 \text{ A, T}_{J} = 175 ^{\circ}\text{C}$	9, 10
Is	Continuous Diode Forward Current		47	Α	V _{GS} = -4 V, T _C = 25°C	
I _{SM}	Diode pulse Current		251	Α	V_{GS} = -4 V, pulse width t_P limited by T_{jmax}	
t _{rr}	Reverse Recover time	29		ns		
Q _{rr}	Reverse Recovery Charge	372		nC	$V_{GS} = -4 \text{ V}, I_{SD} = 33.5 \text{ A}, V_{R} = 500 \text{ V}$ dif/dt = 2185 A/ μ s, $T_{J} = 175 ^{\circ}\text{C}$	
I _{rrm}	Peak Reverse Recovery Current	23		Α		
t _{rr}	Reverse Recover time	20		ns		
Q _{rr}	Reverse Recovery Charge	601		nC	V _{ss} = -4 V, I _{sp} = 33.5 A, V _R = 500 V dif/dt = 6235 A/µs, T _I = 175 °C	
I _{rrm}	Peak Reverse Recovery Current	52		Α		

Thermal Characteristics

Symbol	Parameter	Тур.	Unit	Test Conditions	Note
R _{θJC}	Thermal Resistance from Junction to Case	0.45	°C/W		Fig. 21



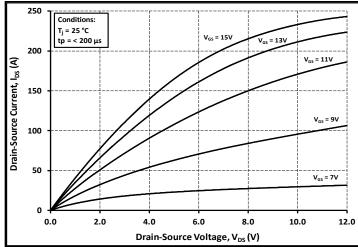
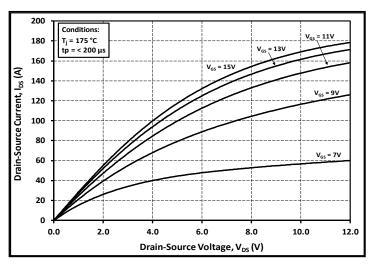


Figure 1. Output Characteristics T_J = -40 °C

Figure 2. Output Characteristics T_J = 25 °C



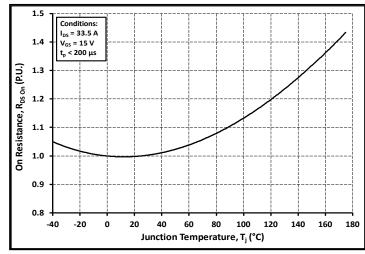
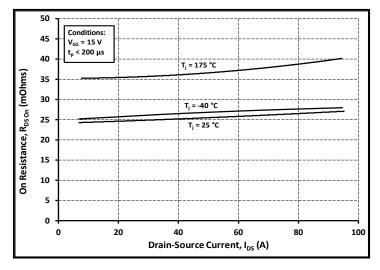


Figure 3. Output Characteristics T_J = 175 °C

Figure 4. Normalized On-Resistance vs. Temperature



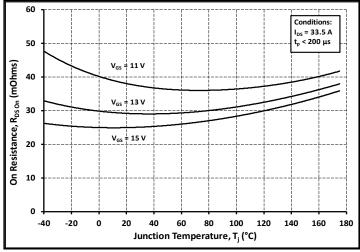
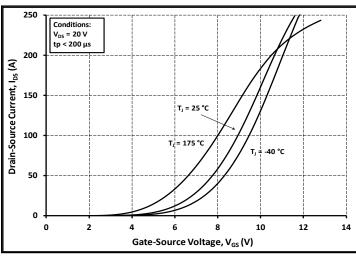


Figure 5. On-Resistance vs. Drain Current For Various Temperatures

Figure 6. On-Resistance vs. Temperature For Various Gate Voltage





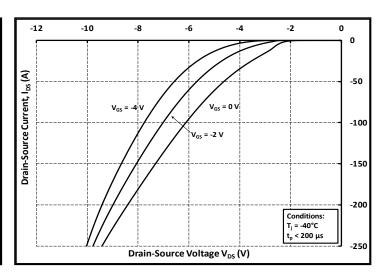


Figure 8. Body Diode Characteristic at -40 °C

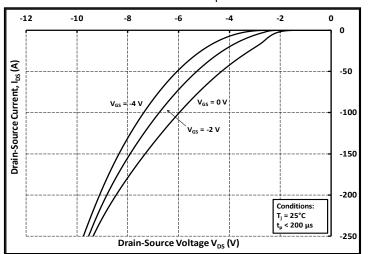


Figure 9. Body Diode Characteristic at 25 °C

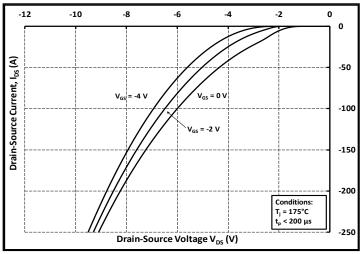


Figure 10. Body Diode Characteristic at 175 °C

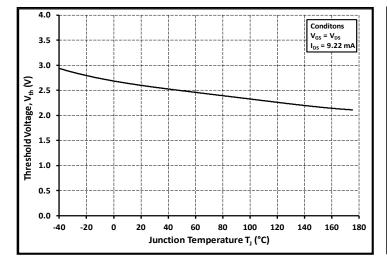


Figure 11. Threshold Voltage vs. Temperature

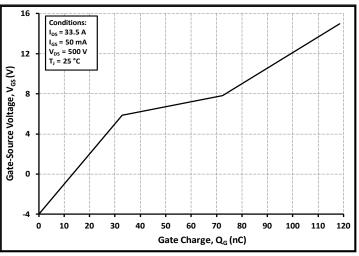
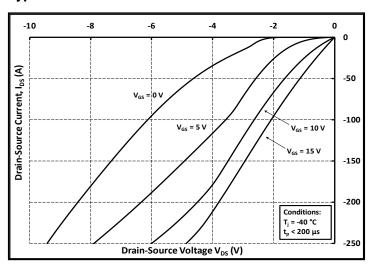


Figure 12. Gate Charge Characteristics



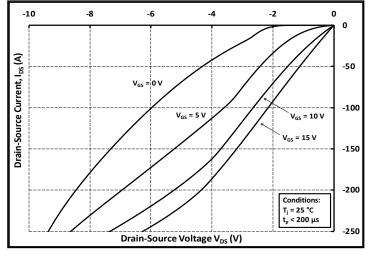
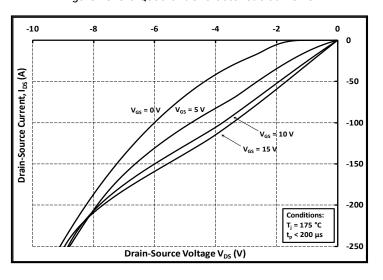


Figure 13. 3rd Quadrant Characteristic at -40 °C





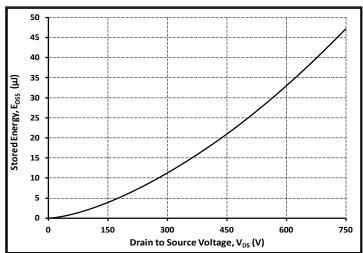
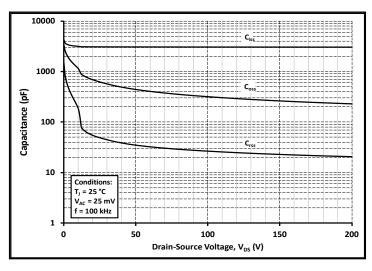


Figure 15. 3rd Quadrant Characteristic at 175 °C

Figure 16. Output Capacitor Stored Energy



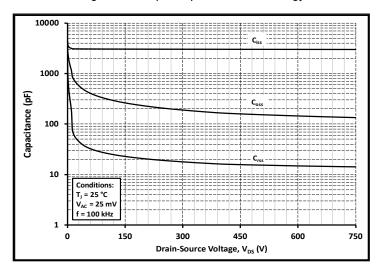
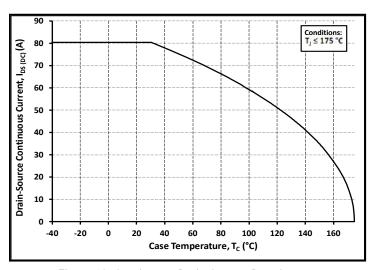


Figure 17. Capacitances vs. Drain-Source Voltage (0 - 200V)

Figure 18. Capacitances vs. Drain-Source Voltage (0 - 750V)



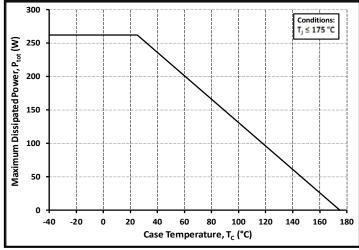
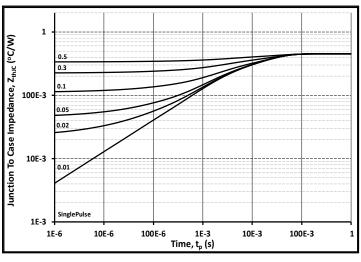


Figure 19. Continuous Drain Current Derating vs.

Case Temperature

Figure 20. Maximum Power Dissipation Derating vs.

Case Temperature



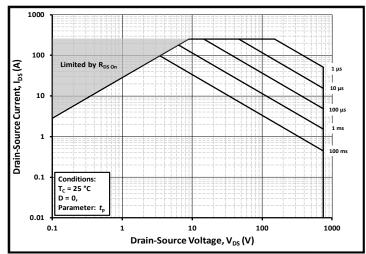
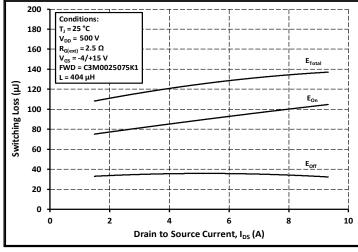


Figure 21. Transient Thermal Impedance (Junction - Case)

Figure 22. Safe Operating Area



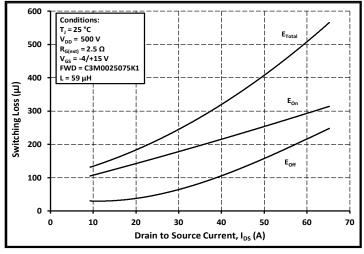


Figure 23. Clamped Inductive Switching Energy vs. Drain Current (V_{DD} = 500V)

Figure 24. Clamped Inductive Switching Energy vs. Drain Current (V_{DD} = 500V)

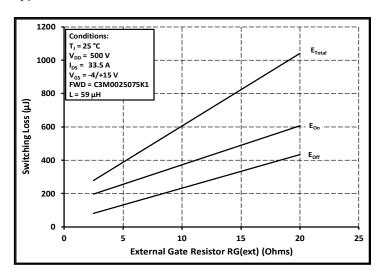


Figure 25. Clamped Inductive Switching Energy vs. $R_{\text{G(ext)}}$

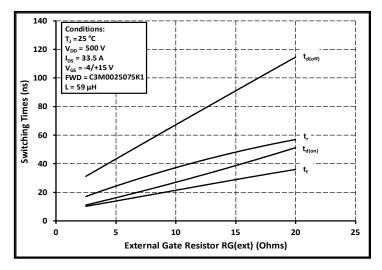


Figure 27. Switching Times vs. $R_{G(ext)}$

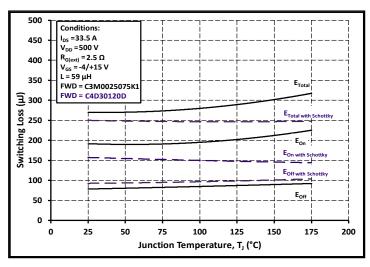


Figure 26. Clamped Inductive Switching Energy vs.
Temperature

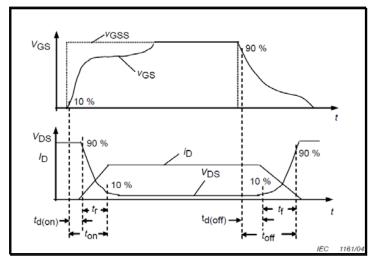


Figure 28. Switching Times Definition

9

Test Circuit Schematic

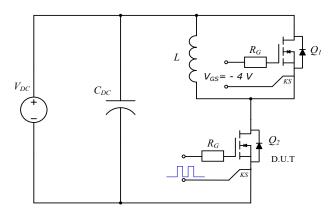
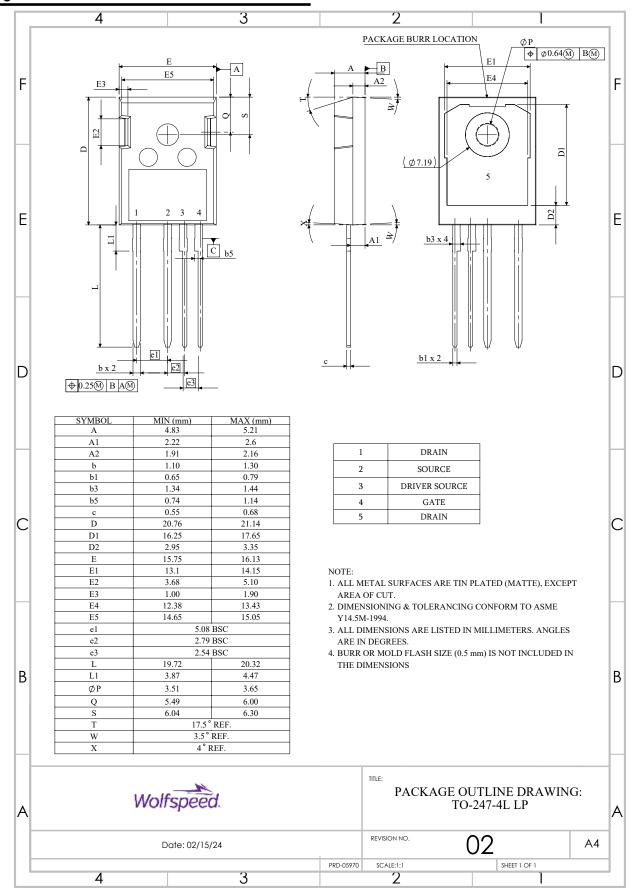


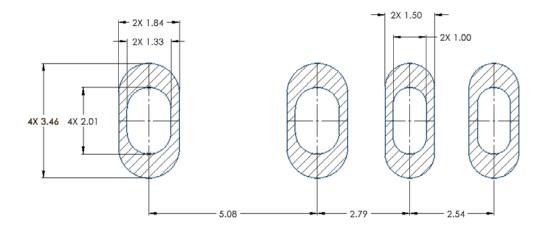
Figure 29. Clamped Inductive Switching Waveform Test Circuit

Package Dimensions



Recommended Solder Pad Layout

All dimensions in mm



Revision history

Document Version	Date of release	Descriptiion of changes
1.0	March-2024	Initial datasheet

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